

Product data sheet

1. General description

Dual ultrafast power diode in a TO220 plastic package.

2. Features and benefits

- · Soft recovery characteristic minimizes power consuming oscillations
- Very low on-state losses
- Fast switching
- High thermal cycling performance
- Low thermal resistance
- Low forward voltage drop

3. Applications

• Output rectifiers in high-frequency switched-mode power supplies

4. Quick reference data

Fable 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values			Unit	
Absolute	e maximum rating						
V_{RRM}	repetitive peak reverse voltage		400			V	
I _{O(AV)}	average output current	SQW; δ = 0.5; T _{mb} ≤ 115 °C; both diodes conducting; Fig. 1; Fig. 2	20		A		
I _{FRM}	repetitive peak forward current	δ = 0.5 ; $t_{\rm p}$ = 25 µs; $T_{\rm mb}$ ≤ 115 °C; per diode	20			A	
I _{FSM}	non-repetitive peak	SIN; t_p = 10 ms; $T_{j(init)}$ = 25 °C; per diode	120			А	
	forward current	SIN; t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; per diode	132			А	
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit	
Static ch	aracteristics						
V _F	forward voltage	Forward voltage $I_F = 10 \text{ A}; T_j = 150 \text{ °C}; Fig. 4$		-	0.87	1.05	V
Dynamic	characteristics			,			
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \underline{Fig. 6}; \underline{Fig. 7}$		-	50	60	ns

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	mb	
2	К	cathode	۲ Y	
3	A2	anode 2		A1 A2 K sym125

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	Name		method	quantity	version	issue date		
BYV34-400	TO220	BYV34-400,127	Tube	50	SOT78	13-Jun-2008		

7. Marking

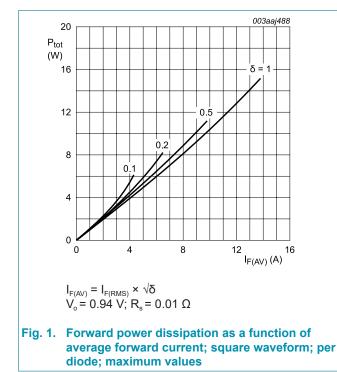
Table 4. Marking codes						
	Type number	Marking codes				
	BYV34-400	BYV34-400				

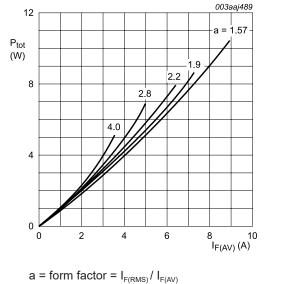
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		400	V
V_{RWM}	crest working reverse voltage		400	V
V _R	reverse voltage	T _{mb} ≤ 138 °C; DC	400	V
I _{O(AV)}	average output current	SQW; δ = 0.5; T _{mb} ≤ 115 °C; both diodes conducting; Fig. 1; Fig. 2	20	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 µs; T _{mb} ≤ 115 °C; per diode	20	A
I _{FSM}	non-repetitive peak	SIN; t_p = 10 ms; $T_{j(init)}$ = 25 °C; per diode	120	А
	forward current	SIN; t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; per diode	132	А
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C



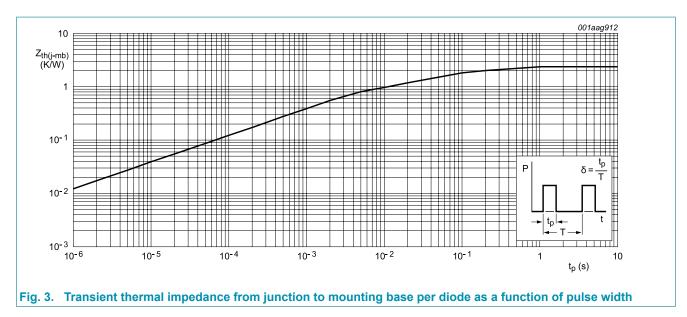


a = form factor = $I_{F(RMS)}/I_{F(AV)}$ V_o = 0.94 V; R_s = 0.01 Ω

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; per diode; maximum values

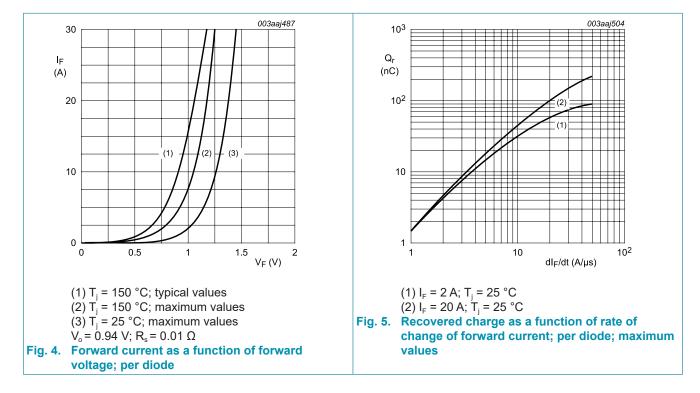
9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; both diodes conducting	-	-	1.6	K/W
		with heatsink compound; per diode; Fig. <u>3</u>	-	-	2.4	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient		-	60	-	K/W



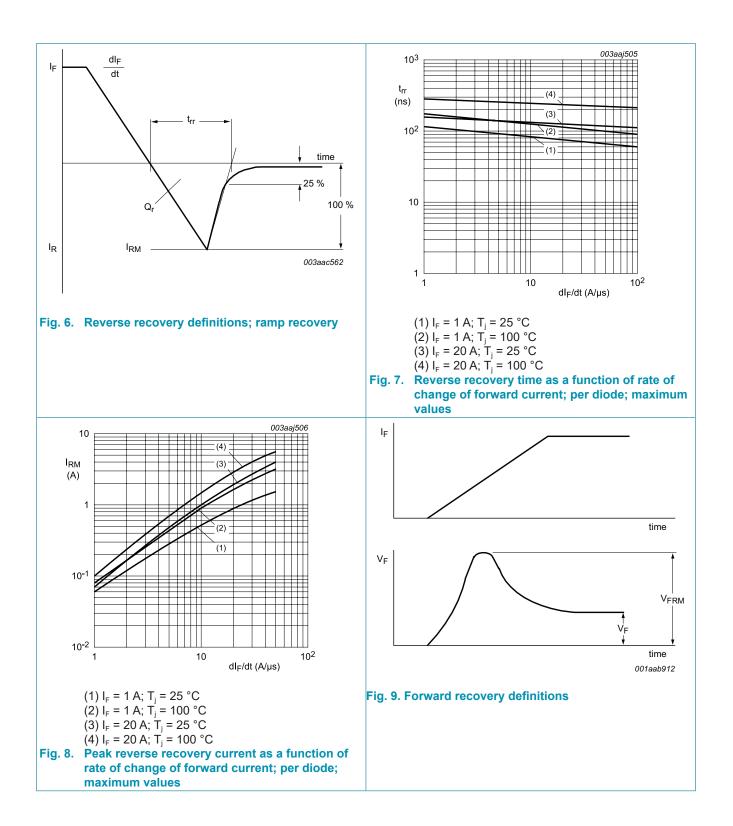
10. Characteristics

Symbol	Parameter	Conditions	Mi	n Typ	Max	Unit
Static cha	aracteristics					
V _F	forward voltage	I _F = 20 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.1	1.35	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 4</u>	-	0.87	1.05	V
I _R	reverse current	V _R = 400 V; T _j = 25 °C	-	10	50	μA
		V _R = 400 V; T _j = 100 °C	-	0.2	0.6	mA
Dynamic	characteristics				_	
Q _r	recovered charge	$I_F = 2 A; V_R = 30 V; dI_F/dt = 20 A/\mu s;$ Fig. 5; Fig. 6	-	50	50	nC
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 6; Fig. 7</u>	-	50	60	ns
I _{RM}	peak reverse recovery current	$I_F = 10 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 100 ^\circ\text{C}; \text{ Fig. 6}; \text{ Fig. 8}$	-	4	5	A
V _{FRM}	forward recovery voltage	I _F = 10 A; dI _F /dt = 100 A/μs; T _j = 25 °C; Fig. <u>9</u>	-	2.5	-	V

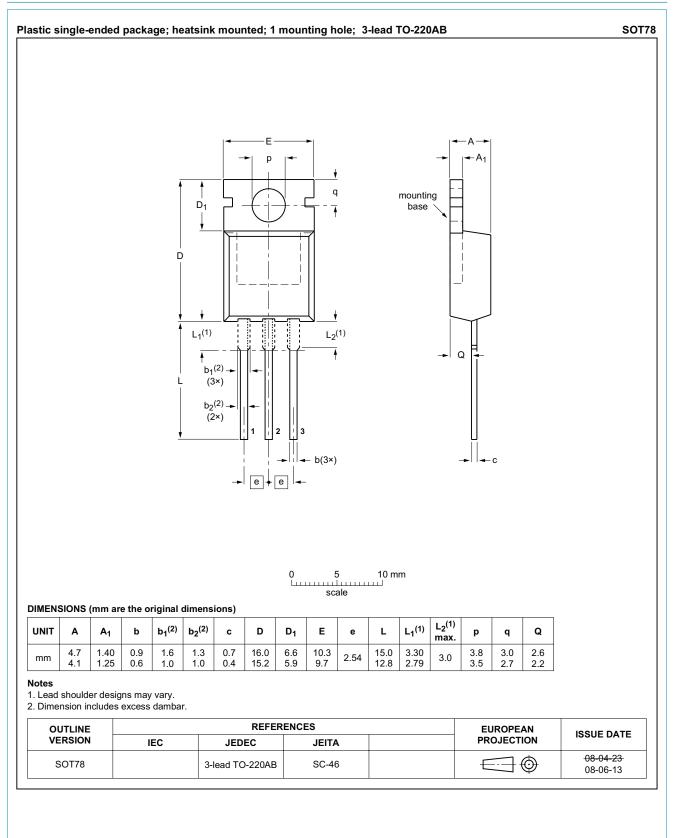


Dual ultrafast power diode

BYV34-400



11. Package outline



BYV34-400

Dual ultrafast power diode

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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